

100V N-Channel Enhancement Mode MOSFET

Description

The PECN1012SR uses Shield Gate Trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Conduction and switching losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and C_{rss} .

General Features

- ◆ $V_{DS} = 100V$ $I_D = 12A$
 $R_{DS(ON)}(Typ.) = 7.5m\Omega$ @ $V_{GS} = 10V$
 $R_{DS(ON)}(Typ.) = 9.5m\Omega$ @ $V_{GS} = 4.5V$
- ◆ Lead free product is acquired
- ◆ Surface mount package

Application

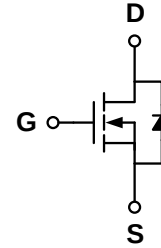
- ◆ High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- ◆ Networking DC-DC Power System
- ◆ Load switch

Package

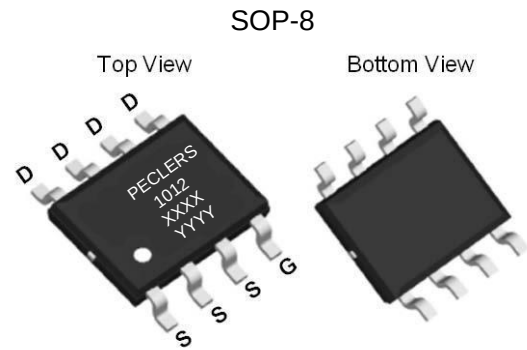
- ◆ SOP-8

100% UIS TESTED!
100% ΔV_{ds} TESTED!

Schematic diagram



Marking and pin assignment



XXXX—Date Code
 YYYY—Quality Code



Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
PECN1012SR	-55°C to +150°C	SOP-8	4000

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

parameter		symbol	limit	unit
Drain-source voltage		V_{DS}	100	V
Gate-source voltage		V_{GS}	±20	V
Continuous Drain Current	TC=25°C	I_D	12	A
	TC=100°C		8	
Pulsed Drain Current		I_{DP}	48	A
Avalanche energy(L=0.1mH)		EAS	155	mJ
Maximum power dissipation	TC=25°C	P_D	3.5	W
Power Dissipation – Derate above 25°C	TC=25°C		2	
Operating junction Temperature range		T_j	-55—150	°C

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	100	-	-	V
BVDSS Temperature Coefficient	ΔBV _{DSS} /ΔT _J	Reference to 25℃,ID=1mA		40		mV/℃
Zero gate voltage drain current	I _{DSS}	V _{DS} =100V, V _{GS} =0V	-	-	1	μA
		T _J =85℃	-	-	10	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1.0	1.6	2.5	V
Drain-source on-state resistance ¹	R _{DS(ON)}	V _{GS} =10V, I _D =12A	-	7.5	10	mΩ
		V _{GS} =4.5V, I _D =12A	-	9.5	13	
On Status Drain Current	I _{D(ON)}	V _{DS} =10V, V _{GS} =4V	-	30	-	A
Diode Characteristics						
Diode Forward Voltage ¹	V _{SD}	I _{SD} =12A,V _{GS} =0V	-	0.8	1.2	V
Diode Continuous Forward Current	I _S		-	-	12	A
Reverse Recovery Time	t _{rr}	I _F = I _S , dI/dt=100A/us	-	75	-	ns
Reverse Recovery Charge	Q _{rr}		-	145	-	nC
Dynamic Characteristics ²						
Gate Resistance	R _G	V _{GS} =0V, V _{DS} =0V,f=1MHz	-	3.3	-	Ω
Input capacitance	C _{ISS}	V _{GS} =0V ,V _{DS} =50V f=1.0MHz	-	3000	-	pF
Output capacitance	C _{OSS}		-	270	-	
Reverse transfer capacitance	C _{RSS}		-	17.5	-	
Turn-on delay time	t _{D(ON)}	V _{DD} =50V, I _D =12A, V _{GS} =10V, R _{GEN} =1.6Ω	-	11	-	ns
Turn-on Rise time	tr		-	7	-	
Turn-off delay time	t _{D(OFF)}		-	30	-	
Turn-off Fall time	tf		-	4	-	
Total gate charge	Q _g	V _{GS} =10V, I _D =12A,V _{DS} =50V	-	45		nC
Gate-source charge	Q _{gs}		-	11.5		
Gate-drain charge	Q _{gd}		-	6	-	

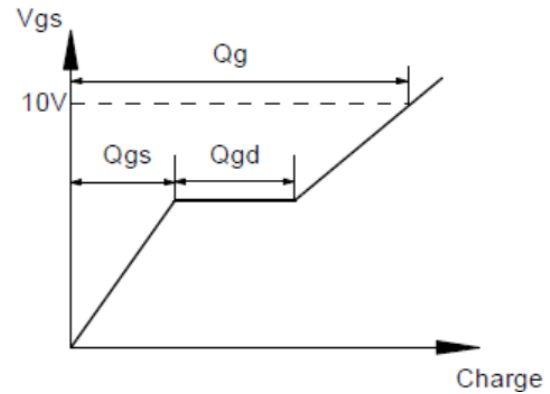
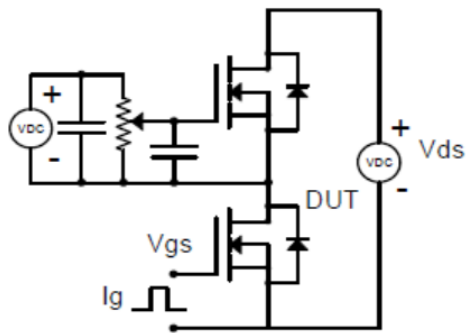
Note: 1: Pulse test; pulse width $\leq 300ns$, duty cycle $\leq 2\%$.

2: Guaranteed by design, not subject to production testing.

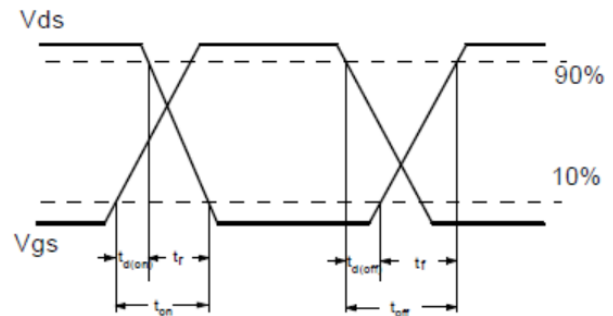
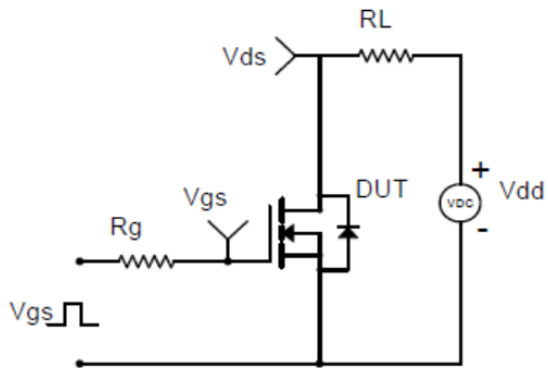
Thermal Characteristics

Parameter	Symbol	Typical	Unit
Thermal Resistance-Junction to Case	$R_{\theta jc}$	1.7	°C/W
Thermal Resistance junction-to ambient	$R_{\theta ja}$	62.5	

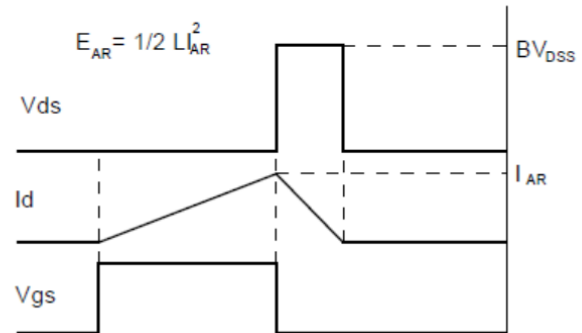
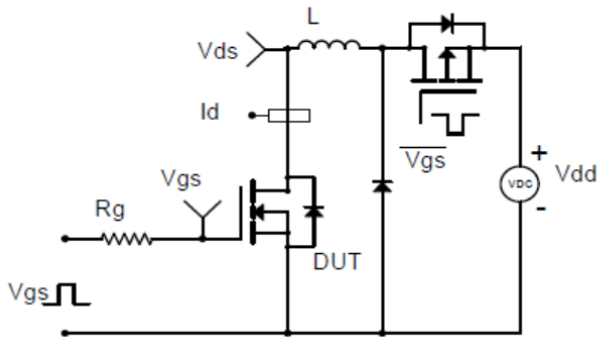
Gate Charge Test Circuit & Waveform



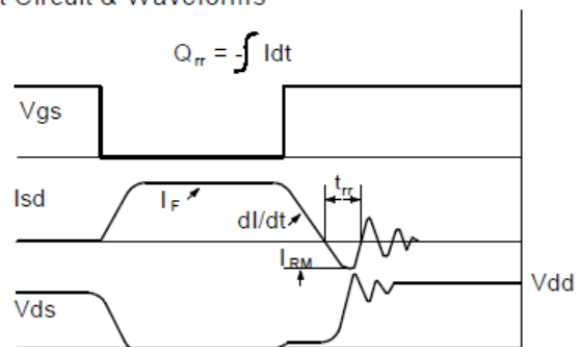
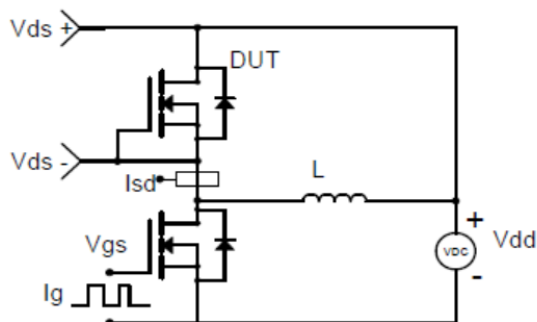
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

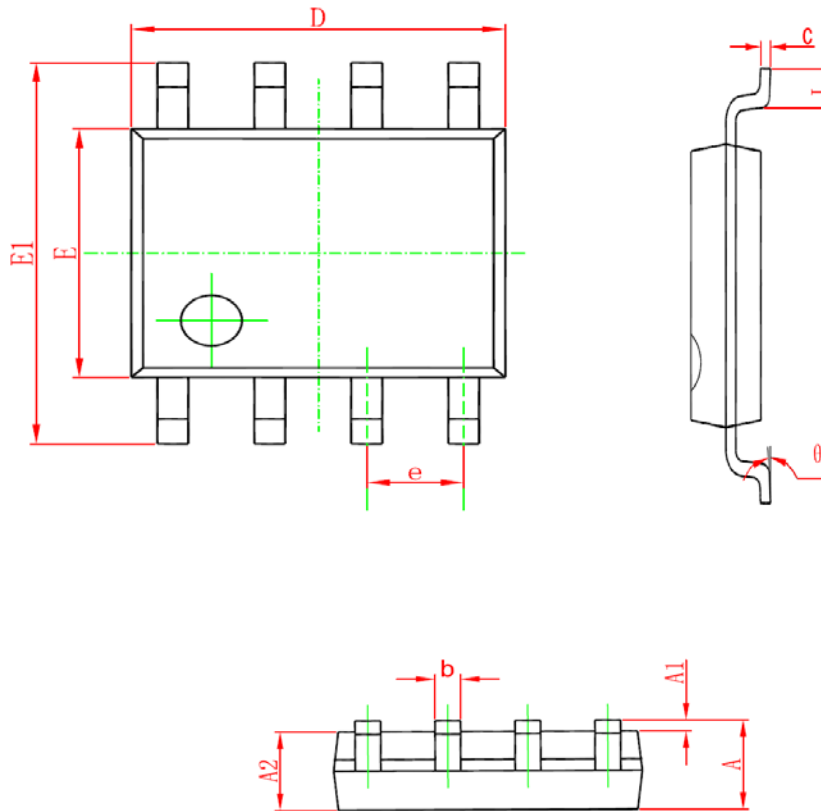


Diode Recovery Test Circuit & Waveforms



Package Information

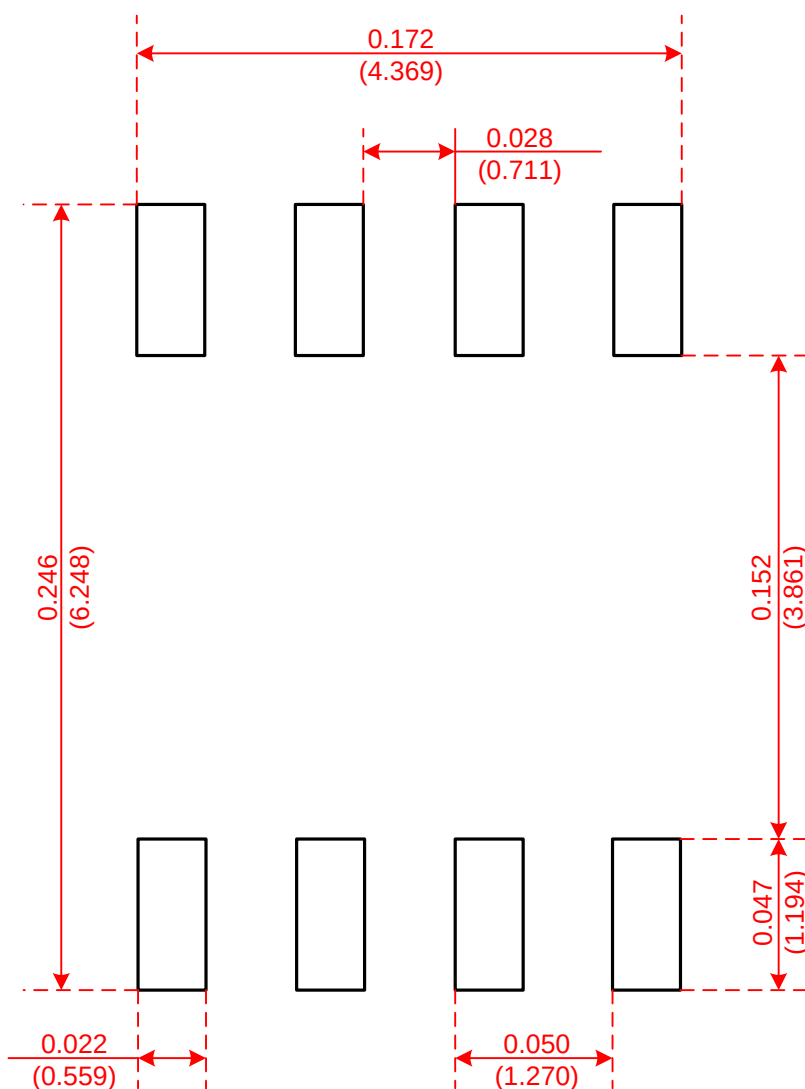
- SOP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

Recommended Minimum Pads

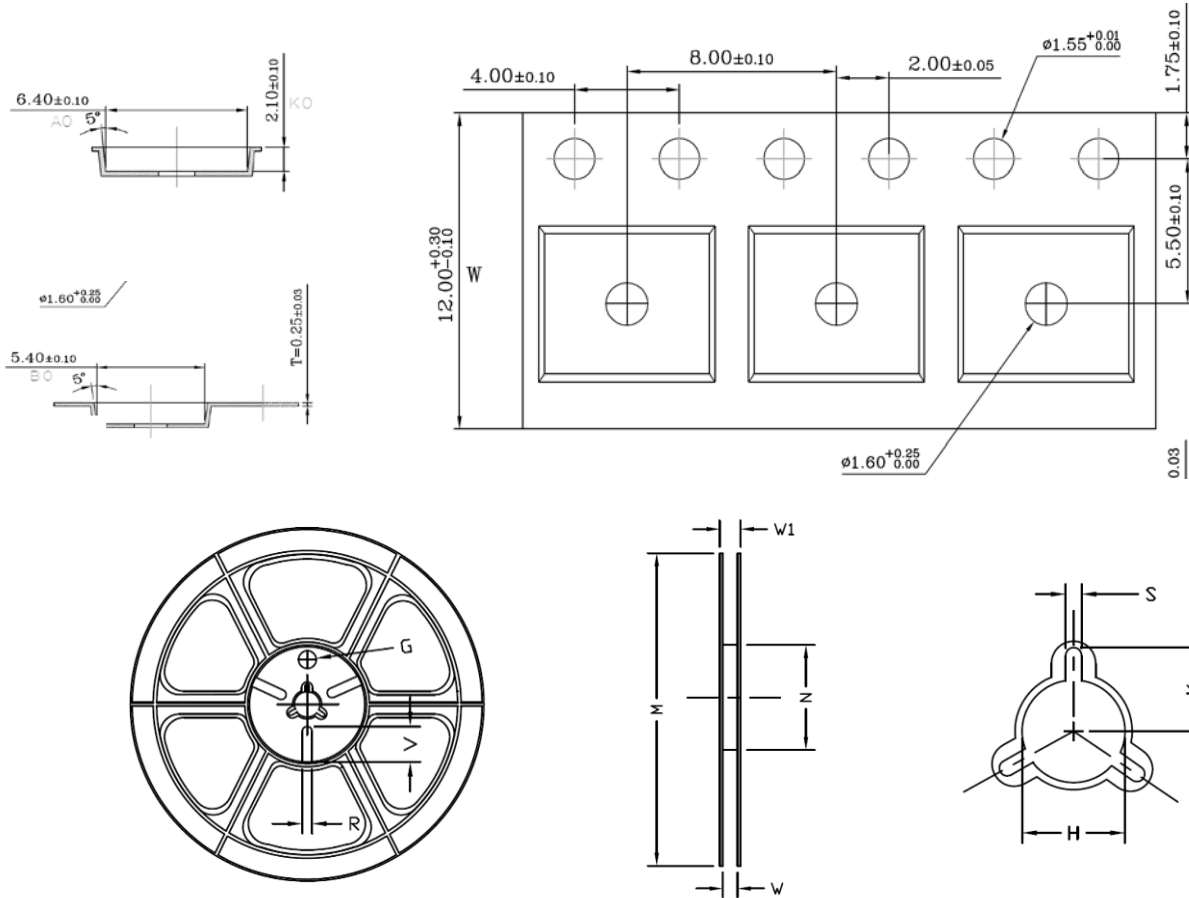
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Recommended Minimum Pads
Dimensions in Inches/(mm)

Tape and Reel

- SOP-8



Tape Size	Reel Size	M	N	W	W1	H	K	S	G	R	V
12mm	Φ330	Φ330.00 ±0.50	Φ97.00 ±0.30	13.00 ±0.30	17.40 ±1.00	Φ13.00 ±0.5	10.6	2.00 ±0.50	—	—	—

Unit Per Reel:
4000pcs

